



# Product Change Notification

**Change Notification #:** 116077 - 00  
**Change Title:** Select Intel® Compute Modules  
HNS2600BPB, HNS2600BPB24,  
HNS2600BPS, HNS2600BPS24,  
HNS2600BPQ & HNS2600BPQ24,  
PCN 116077-00, Product Design,  
Updated Trusted Platform Module (TPM)  
**Date of Publication:** February 12, 2018

## Key Characteristics of the Change:

Product Design

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material: *</b>	February 27, 2018
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\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

## Description of Change to the Customer:

Intel is implementing the following change on select Intel® Compute Modules HNS2600BPB, HNS2600BPB24, HNS2600BPS, HNS2600BPS24, HNS2600BPQ and HNS2600BPQ24:

1. Update the TPM from H50896-001 to J91313-001.
2. Improve the stability of 5V standby Power by using material IRF7425 for location Q3C1 and change chip resistor on location R3C3 from 10ohm to 10Kohm.

## Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation.

### Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre-TA#	Pre PBA#	Post TA#	Post PBA#
HNS2600BPQ	948901	J48509-002	H87927-551	J48509-003	H87927-552
HNS2600BPB24	948903	J48508-002	H87926-551	J48508-003	H87926-552
HNS2600BPQ24	948904	J48510-002	H87927-551	J48510-003	H87927-552
HNS2600BPB	948924	J48507-002	H87926-551	J48507-003	H87926-552
HNS2600BPS	952610	J48511-002	J36547-351	J48511-003	J36547-352
HNS2600BPS24	952611	J48513-002	J36547-351	J48513-003	J36547-352

### PCN Revision History:

**Date of Revision:**

February 12, 2018

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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